

PM/P/P Cores Halves/EP Cores and Accessories

Series/Type: B65841

The following products presented in this data sheet are being withdrawn.

Ordering Code	Substitute Product	Date of Withdrawal	Deadline Last Orders	Last Shipments
B65841A0000Y066		2020-08-14	2020-11-13	2021-02-12

Please contact your nearest TDK sales office if you need support in selecting a suitable substitute. The addresses of our worldwide sales network are presented at www.tdk-electronics.tdk.com/sales.



EP 10

Core B65841

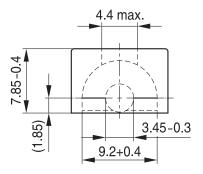
- To IEC 62317-5
- For transformers featuring high inductance and low overall height
- For power applications
- Delivery mode: sets

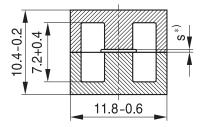
Magnetic characteristics (per set)

 $\Sigma I/A = 1.7 \text{ mm}^{-1}$ $I_e = 19.2 \text{ mm}$ $A_e = 11.3 \text{ mm}^2$ $A_{min} = 8.5 \text{ mm}^2$

= 217 mm³

Approx. weight 2.8 g/set





*) gapped (one-sided) FEP0076-Y-E

Gapped (A_L values/air gaps examples)

Material	A _L value	s	μ_{e}	Ordering code
		approx.		
	nH	mm		
T38	63 ±3%	0.22	85	B65841A0063A038
	100 ±3%	0.14	135	B65841A0100A038
	160 ±5%	0.09	216	B65841A0160J038
	200 ±6%	0.07	270	B65841A0200C038
	250 ±7%	0.05	338	B65841A0250E038
T57	63 ±3%	0.22	85	B65841A0063A057
	100 ±3%	0.14	135	B65841A0100A057
	160 ±5%	0.09	216	B65841A0160J057
	200 ±6%	0.07	270	B65841A0200C057
	250 ±7%	0.05	338	B65841A0250E057
N45	63 ±3%	0.22	85	B65841A0063A045
	100 ±3%	0.14	135	B65841A0100A045
	160 ±5%	0.08	216	B65841A0160J045
	200 ±6%	0.07	270	B65841A0200C045
	250 ±7%	0.05	338	B65841A0250E045
N87	63 ±3%	0.22	85	B65841A0063A087
	100 ±3%	0.13	135	B65841A0100A087
	160 ±5%	0.08	216	B65841A0160J087
	200 ±6%	0.06	270	B65841A0200C087
	250 ±7%	0.05	338	B65841A0250E087



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Ungapped

Material	A _L value	μ_{e}	P _V	Ordering code
	nH		W/set	
N45	1600 +30/–20%	2160		B65841A0000R045
N30	2000 +30/–20%	2700		B65841A0000R030
T57	1600 +30/–20%	2160		B65841A0000R057
T65	2900 +30/–20%	3920		B65841A0000R065
T38	4800 +40/–30%	6490		B65841A0000Y038
T66	6000 +40/–30%	8100		B65841A0000Y066
N87	1100 +30/–20%	1480	< 0.1 (200 mT, 100 kHz, 100 °C)	B65841A0000R087

Other A_L values/air gaps and materials available on request – see Processing remarks on page 6.



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Accessories B65842

Coil former, squared pins

Material: GFR thermosetting plastic (UL 94 V-0, insulation class to IEC 60085:

F

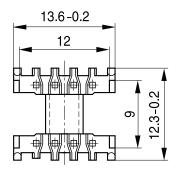
max. operating temperature 155 °C), color code black

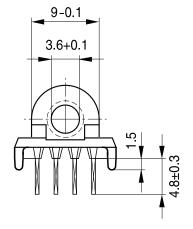
Sumikon PM 9630® [E41429 (M)], SUMITOMO BAKELITE CO LTD

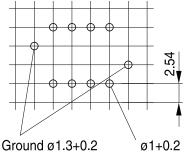
Solderability: to IEC 60068-2-20, test Ta, method 1 (aging 3): 235 °C, 2 s Resistance to soldering heat: to IEC 68-2-20, test Tb, method 1B: 350 °C, 3.5 s

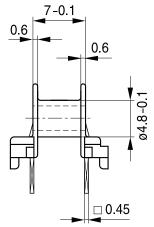
Winding: see Processing notes, 2.1

Sections	A _N mm ²	I _N mm	A_R value $\mu\Omega$	Terminals	Ordering code
1	12.1	21.5	61.3	8	B65842W1008D001
2	11.6	21.5	63.7	8	B65842W1008D002

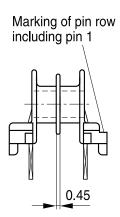








Hole arrangement View in mounting direction



FEP0011-S-E



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Mounting assembly

The set comprises a yoke and a clamp

Yoke

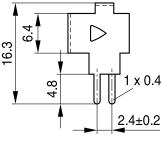
Made of rolled steel (0.4 mm) with ground terminal (tinned)

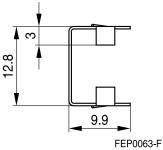
Clamp

Spring clamp, made of bronze (0.3 mm), tinned

	Ordering code
Complete mounting assembly	B65842S2000X000

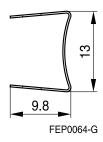
Yoke





Clamp







Cautions and warnings

Mechanical stress and mounting

Ferrite cores have to meet mechanical requirements during assembling and for a growing number of applications. Since ferrites are ceramic materials one has to be aware of the special behavior under mechanical load.

As valid for any ceramic material, ferrite cores are brittle and sensitive to any shock, fast temperature changing or tensile load. Especially high cooling rates under ultrasonic cleaning and high static or cyclic loads can cause cracks or failure of the ferrite cores.

For detailed information see data book, chapter "General - Definitions, 8.1".

Effects of core combination on A_I value

Stresses in the core affect not only the mechanical but also the magnetic properties. It is apparent that the initial permeability is dependent on the stress state of the core. The higher the stresses are in the core, the lower is the value for the initial permeability. Thus the embedding medium should have the greatest possible elasticity.

For detailed information see data book, chapter "General - Definitions, 8.1".

Heating up

Ferrites can run hot during operation at higher flux densities and higher frequencies.

NiZn-materials

The magnetic properties of NiZn-materials can change irreversible in high magnetic fields.

Ferrite Accessories

EPCOS ferrite accessories have been designed and evaluated only in combination with EPCOS ferrite cores. EPCOS explicitly points out that EPCOS ferrite accessories or EPCOS ferrite cores may not be compatible with those of other manufacturers. Any such combination requires prior testing by the customer and will be at the customer's own risk.

EPCOS assumes no warranty or reliability for the combination of EPCOS ferrite accessories with cores and other accessories from any other manufacturer.

Processing remarks

The start of the winding process should be soft. Else the flanges may be destroyed.

- Too strong winding forces may blast the flanges or squeeze the tube that the cores can not be mounted any more.
- Too long soldering time at high temperature (>300 °C) may effect coplanarity or pin arrangement.
- Not following the processing notes for soldering of the J-leg terminals may cause solderability problems at the transformer because of pollution with Sn oxyde of the tin bath or burned insulation of the wire. For detailed information see chapter "Processing notes", section 2.2.
- The dimensions of the hole arrangement have fixed values and should be understood as a recommendation for drilling the printed circuit board. For dimensioning the pins, the group of holes can only be seen under certain conditions, as they fit into the given hole arrangement. To avoid problems when mounting the transformer, the manufacturing tolerances for positioning the customers' drilling process must be considered by increasing the hole diameter.

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Cautions and warnings

Display of ordering codes for EPCOS products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of EPCOS, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.epcos.com/orderingcodes.



Symbols and terms

Symbol	Meaning	Unit
A	Cross section of coil	mm ²
A_{e}	Effective magnetic cross section	mm ²
A_L	Inductance factor; A _L = L/N ²	nH
A_{L1}	Minimum inductance at defined high saturation ($\triangleq \mu_a$)	nH
A _{min}	Minimum core cross section	mm ²
A_N	Winding cross section	mm ²
A_R	Resistance factor; $A_R = R_{Cu}/N^2$	$\mu\Omega = 10^{-6} \Omega$
В	RMS value of magnetic flux density	Vs/m ² , mT
ΔB	Flux density deviation	Vs/m ² , mT
Â	Peak value of magnetic flux density	Vs/m ² , mT
ΔÂ	Peak value of flux density deviation	Vs/m ² , mT
B_{DC}	DC magnetic flux density	Vs/m ² , mT
B_R	Remanent flux density	Vs/m ² , mT
B_S	Saturation magnetization	Vs/m ² , mT
C_0	Winding capacitance	F = As/V
CDF	Core distortion factor	mm ^{-4.5}
DF	Relative disaccommodation coefficient DF = d/μ_i	
d	Disaccommodation coefficient	
E_a	Activation energy	J
f	Frequency	s ^{−1} , Hz
f _{cutoff}	Cut-off frequency	s−1, Hz
f _{max}	Upper frequency limit	s ^{−1} , Hz
f _{min}	Lower frequency limit	s−1, Hz
f _r	Resonance frequency	s ^{−1} , Hz
f_{Cu}	Copper filling factor	
g	Air gap	mm
Н	RMS value of magnetic field strength	A/m
Ĥ	Peak value of magnetic field strength	A/m
H_{DC}	DC field strength	A/m
H _c	Coercive field strength	A/m
h	Hysteresis coefficient of material	10 ⁻⁶ cm/A
h/μ_i^2	Relative hysteresis coefficient	10 ⁻⁶ cm/A
1	RMS value of current	Α
I_{DC}	Direct current	Α
î	Peak value of current	Α
J	Polarization	Vs/m ²
k	Boltzmann constant	J/K
k ₃	Third harmonic distortion	
k _{3c}	Circuit third harmonic distortion	
L	Inductance	H = Vs/A



Symbols and terms

Symbol	Meaning	Unit
Δ L/L	Relative inductance change	Н
L_0	Inductance of coil without core	Н
L_H	Main inductance	Н
L_p	Parallel inductance	Н
L _{rev}	Reversible inductance	Н
L_s	Series inductance	Н
l _e	Effective magnetic path length	mm
I _N	Average length of turn	mm
N	Number of turns	
P_{Cu}	Copper (winding) losses	W
P_{trans}	Transferrable power	W
P_V	Relative core losses	mW/g
PF	Performance factor	
Q	Quality factor (Q = ω L/R _s = 1/tan δ _L)	
R	Resistance	Ω
R_{Cu}	Copper (winding) resistance (f = 0)	Ω
R_h	Hysteresis loss resistance of a core	Ω
ΔR_h	R _h change	Ω
R_i	Internal resistance	Ω
R_p	Parallel loss resistance of a core	Ω
R_s	Series loss resistance of a core	Ω
R_{th}	Thermal resistance	K/W
R_V	Effective loss resistance of a core	Ω
S	Total air gap	mm
T	Temperature	°C
ΔT	Temperature difference	K
T_C	Curie temperature	°C
t	Time	S
t_{v}	Pulse duty factor	
$tan \ \delta$	Loss factor	
tan δ_{L}	Loss factor of coil	
tan δ_r	(Residual) loss factor at H $ ightarrow$ 0	
tan δ_{e}	Relative loss factor	
tan δ_{h}	Hysteresis loss factor	
tan δ/μ _i	Relative loss factor of material at $H \rightarrow 0$	
U	RMS value of voltage	V
Û	Peak value of voltage	V
V_{e}	Effective magnetic volume	mm ³
Z	Complex impedance	Ω
Z_n	Normalized impedance $ Z _n = Z /N^2 \times \varepsilon (l_e/A_e)$	Ω/mm



Symbols and terms

Symbol	Meaning	Unit
α	Temperature coefficient (TK)	1/K
α_{F}	Relative temperature coefficient of material	1/K
α_{e}	Temperature coefficient of effective permeability	1/K
ε_{r}	Relative permittivity	
Φ	Magnetic flux	Vs
η	Efficiency of a transformer	
η _B	Hysteresis material constant	mT-1
η _i	Hysteresis core constant	$A^{-1}H^{-1/2}$
λ_{s}	Magnetostriction at saturation magnetization	
ı	Relative complex permeability	
$\mathfrak{1}_0$	Magnetic field constant	Vs/Am
la	Relative amplitude permeability	
l _{app}	Relative apparent permeability	
le	Relative effective permeability	
l _i	Relative initial permeability	
ι _p '	Relative real (inductive) component of $\overline{\mu}$ (for parallel components)	
ւ _թ "	Relative imaginary (loss) component of $\overline{\mu}$ (for parallel components)	
ι_{r}	Relative permeability	
ι_{rev}	Relative reversible permeability	
ι _s '	Relative real (inductive) component of $\overline{\mu}$ (for series components)	
ι _s "	Relative imaginary (loss) component of $\overline{\mu}$ (for series components)	
ι_{tot}	Relative total permeability	
	derived from the static magnetization curve	
)	Resistivity	Ω m ⁻¹
ΣΙ/Α	Magnetic form factor	mm ⁻¹
r _{Cu}	DC time constant $\tau_{Cu} = L/R_{Cu} = A_L/A_R$	S
ω	Angular frequency; ω = 2 Π f	s ⁻¹

All dimensions are given in mm.





Important notes

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- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
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